

Customer Information Notification

Issue Date: 02-Jun-2015 Effective Date: 17-Jul-2015

Here's your personalized quality information concerning products Digi-Key purchased from NXP.

For detailed information we invite you to view this notification online

2015050161



Management Summary

Discontinuation of delivery form tray and switch to tape and reel

Change Category

[] Wafer Fab process [] Assembly Process [] Product Marking	[] Design
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[] Electrical spec./Test coverage [] Wafer Fab materials [] Assembly Materials [] Mechanical Specification [] Wafer Fab location [] Assembly Location [] Test Location

[X] Packing/Shipping/Labeling

Discontinuation of delivery form tray and switch to tape and reel

Information Notification

We will stop the delivery of these products in trays and continue the delivery in tape and reel form.

Why do we issue this Information Notification

To streamline the packing variants and eliminate the ones not needed by customers.

Identification of Affected Products

Product identification does not change

Impact

no impact to the product's functionality anticipated.

Data Sheet Revision

A new datasheet will be issued

Additional information

Affected products and sales history information: see attached file

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Cengiz Oezcan

Position Quality Manager PL CWG e-mail address cengiz.oezcan@nxp.com

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

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Changed Orderable	Changed Part	Package	Package	No. Code alle Posts	New part
Part#	12NC	Outline	Name	New Orderable Part#	12NC
		SOT314-			
PCA8576CH/Q900,157	935290244157	2	LQFP64	PCA8576CH/Q900/1,1	935290244118
		SOT314-			
PCF8576CHL/1,157	935290305157	2	LQFP64	PCF8576CHL/1,118	935290305118